

ABSTRACT OF THE DISCLOSURE

A packaging (10) for a component (12) can be attached by means of at least one attachment element (14) to a mounting surface of a superordinate component, whereby the component (12) has an upper surface (12a), a bottom surface (12b) and at least one mounting (12c) for the at least one attachment element (14) continuous from the upper surface (12a) to the bottom surface (12b). The packaging (10) is at least partially substantially rigidly formed and the at least one attachment element (14) inserted in the at least one mounting (12c) is maintained in a position in a positive-locking (form-locking) manner, in which it does not project over the bottom surface (12b) of the component. For packaging of the component (12) into the packaging (10), advantageously an auxiliary element is used.